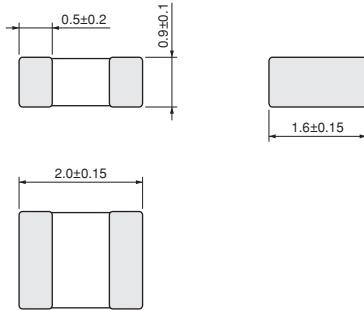


LQM2MPN_G0 Series 0806/2016 (inch/mm)



■ Dimensions



(in mm)

■ Packaging

Code	Packaging	Minimum Quantity
L	ø180mm Embossed Taping	3000
B	Packing in Bulk	1000

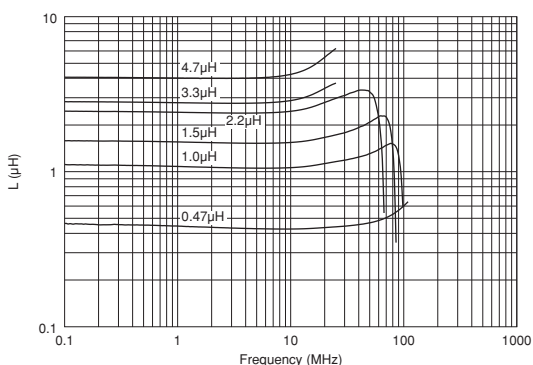
■ Rated Value (□: packaging code)

Part Number	Inductance	Inductance Test Frequency	Rated Current	DC Resistance	Self-Resonance Frequency (min.)
LQM2MPNR47MG0□	0.47μH ±20%	1MHz	1600mA	0.060Ω ±25%	100MHz
LQM2MPNR47NG0□	0.47μH ±30%	1MHz	1600mA	0.060Ω ±25%	100MHz
LQM2MPN1R0NG0□	1.0μH ±30%	1MHz	1400mA	0.085Ω ±25%	60MHz
LQM2MPN1R5MG0□	1.5μH ±20%	1MHz	1200mA	0.11Ω ±25%	50MHz
LQM2MPN1R5NG0□	1.5μH ±30%	1MHz	1200mA	0.11Ω ±25%	50MHz
LQM2MPN2R2MG0□	2.2μH ±20%	1MHz	1200mA	0.11Ω ±25%	40MHz
LQM2MPN2R2NG0□	2.2μH ±30%	1MHz	1200mA	0.11Ω ±25%	40MHz
LQM2MPN3R3NG0□	3.3μH ±30%	1MHz	1200mA	0.12Ω ±25%	30MHz
LQM2MPN4R7MG0□	4.7μH ±20%	1MHz	1100mA	0.14Ω ±25%	20MHz
LQM2MPN4R7NG0□	4.7μH ±30%	1MHz	1100mA	0.14Ω ±25%	20MHz

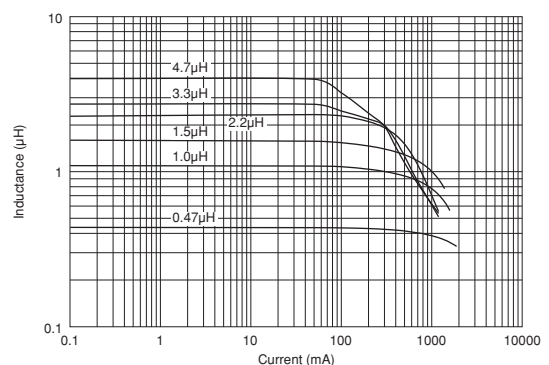
Class of Magnetic Shield: Magnetic shield of ferrite

Operating Temperature Range: -55~125°C

■ Inductance-Frequency Characteristics (Typ.)



■ Inductance-Current Characteristics (Typ.)




Continued on the following page.

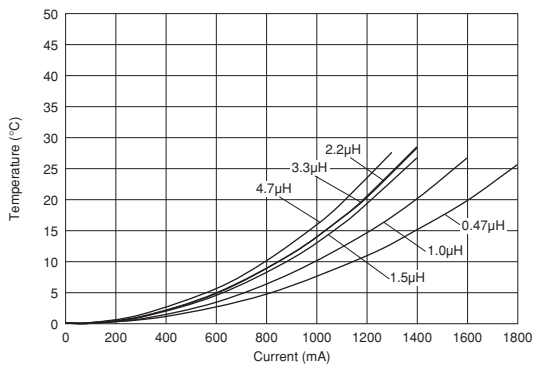
● This data sheet is applied for CHIP INDUCTORS (CHIP COILS) used for General Electronics equipment for your design.

⚠ Note:

- This datasheet is downloaded from the website of Murata Manufacturing co., ltd. Therefore, it's specifications are subject to change or our products in it may be discontinued without advance notice. Please check with our sales representatives or product engineers before ordering.
- This datasheet has only typical specifications because there is no space for detailed specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

 Continued from the preceding page.

■ Temperature Rise Characteristics (Typ.)



■ ⚠ Caution/Notice

⚠ Caution (Rating)

Do not use products beyond the rated current as this may create excessive heat.

Notice

Solderability of Tin plating termination chip might be deteriorated when low temperature soldering profile where peak solder temperature is below the Tin melting point is used. Please confirm the solderability of Tin plating termination chip before use.

● This data sheet is applied for CHIP INDUCTORS (CHIP COILS) used for General Electronics equipment for your design.

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